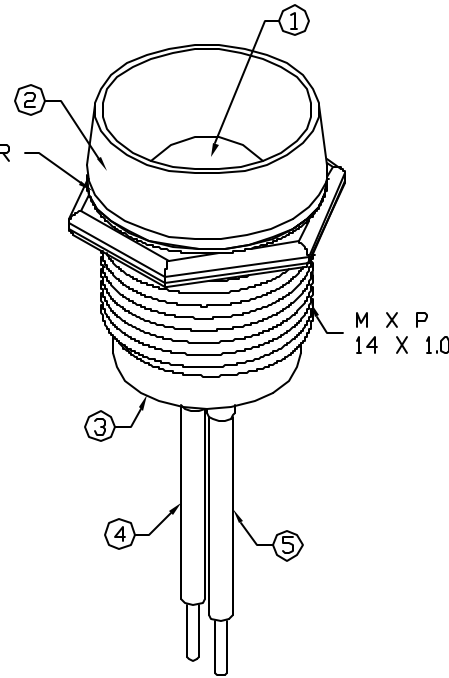
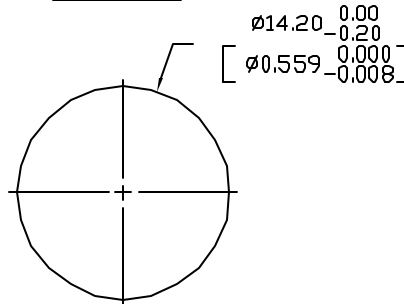


LOCK WASHER



PANEL CUTOUT



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		636		nm	
FORWARD VOLTAGE		2.0	2.5	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		550		med	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$

* $t < 10\mu\text{s}$

NOTES:

- SSL-LX100133SID, RED LED UNMOUNTED LEADS.
- SSI-LXR4915, CHROME HOUSING.
- NEOPRENE RUBBER BUSHING.
- ANODE LEAD: LXP-WST24RDTGC, 24 AWG STRANDED, RED INSULATION, CUT 290mm LONG, STRIP 3mm & 9.5mm.
- CATHODE LEAD: LXP-WST24BLTOC, 24 AWG STRANDED, BLACK INSULATION, CUT 290mm, STRIP 3mm & 9.5mm.
- LXP-HEATSHRINK-2; 1/16" X 37mm (2 PCS.)
- LED IS SECURED INSIDE HOLDER WITH UV GLUE. THEN, INSERT BUSHING.

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= $\begin{matrix} +0.00 \\ -0.00 \end{matrix}$ DECIMAL PRECISION, MAX= $\begin{matrix} +0.00 \\ -0.00 \end{matrix}$ DECIMAL PRECISION.

REV.

PART NUMBER

SSI-LXR4915SID-300

CONFIDENTIAL INFORMATION
THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC, THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.



290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

10mm, 636nm AlInGaP RED LED PANEL INDICATOR,
RED DIFFUSED LENS, 12" WIRE LEADS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:

CHECKED BY:

APPROVED BY:

DATE: 9.8.06

JD

PAGE: 1 OF 1

SCALE: N/A